

## P-Channel Enhancement Mode Power MOSFET

### Description

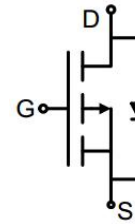
The G400P06S uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge. It can be used in a wide variety of applications.

### General Features

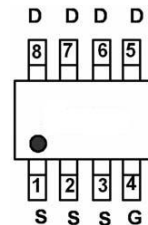
- $V_{DS}$  -60V
- $I_D$  (at  $V_{GS} = -10V$ ) -6A
- $R_{DS(ON)}$  (at  $V_{GS} = -10V$ ) < 40m $\Omega$
- 100% Avalanche Tested
- RoHS Compliant

### Application

- Power switch
- DC/DC converters



Schematic diagram



pin assignment



SOP-8

### Ordering Information

| Device   | Package | Marking | Packaging    |
|----------|---------|---------|--------------|
| G400P06S | SOP-8   | G400P06 | 4000pcs/Reel |

### Absolute Maximum Ratings $T_C = 25^\circ C$ , unless otherwise noted

| Parameter  | Symbol         | Value      | Unit       |
|--|----------------|------------|------------|
| Drain-Source Voltage                             | $V_{DS}$       | -60        | V          |
| Continuous Drain Current                         | $I_D$          | -6         | A          |
| Pulsed Drain Current (note1)                     | $I_{DM}$       | -24        | A          |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 20$   | V          |
| Power Dissipation                                | $P_D$          | 1.7        | W          |
| Single pulse avalanche energy (note2)            | $E_{AS}$       | 144        | mJ         |
| Operating Junction and Storage Temperature Range | $T_J, T_{stg}$ | -55 To 150 | $^\circ C$ |

### Thermal Resistance

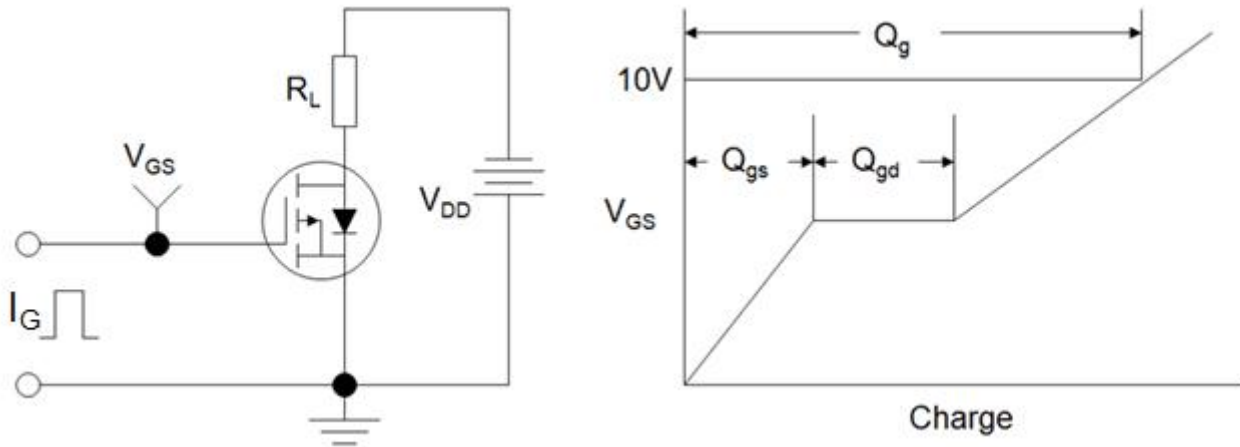
| Parameter                               | Symbol     | Value | Unit         |
|---|------------|-------|--------------|
| Thermal Resistance, Junction-to-Ambient | $R_{thJA}$ | 75    | $^\circ C/W$ |

| Specifications $T_J = 25^\circ\text{C}$ , unless otherwise noted |               |   |       |      |           |            |
|--|---------------|---|-------|------|-----------|------------|
| Parameter  | Symbol        | Test Conditions   | Value |      |           | Unit       |
|  |               |   | Min.  | Typ. | Max.      |            |
| <b>Static Parameters</b>   |               |   |       |      |           |            |
| Drain-Source Breakdown Voltage                                   | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = -250\mu A$                            | -60   | --   | --        | V          |
| Zero Gate Voltage Drain Current                                  | $I_{DSS}$     | $V_{DS} = -60V, V_{GS} = 0V$                              | --    | --   | -1        | $\mu A$    |
| Gate-Source Leakage  | $I_{GSS}$     | $V_{GS} = \pm 20V$  | --    | --   | $\pm 100$ | nA         |
| Gate-Source Threshold Voltage                                    | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = -250\mu A$                        | -2    | -2.5 | -3        | V          |
| Drain-Source On-Resistance                                       | $R_{DS(on)}$  | $V_{GS} = -10V, I_D = -12A$                               | --    | 33   | 40        | m $\Omega$ |
| Forward Transconductance   | $g_{FS}$      | $V_{DS} = -5V, I_D = -12A$                                | --    | 15   | --        | S          |
| <b>Dynamic Parameters</b>  |               |   |       |      |           |            |
| Input Capacitance  | $C_{iss}$     | $V_{GS} = 0V,$<br>$V_{DS} = -30V,$<br>$f = 1.0\text{MHz}$ | --    | 2506 | --        | pF         |
| Output Capacitance   | $C_{oss}$     |   | --    | 112  | --        |            |
| Reverse Transfer Capacitance                                     | $C_{rss}$     |   | --    | 110  | --        |            |
| Total Gate Charge  | $Q_g$         | $V_{DD} = -30V,$<br>$I_D = -12A,$<br>$V_{GS} = -10V$      | --    | 46   | --        | nC         |
| Gate-Source Charge   | $Q_{gs}$      |   | --    | 10   | --        |            |
| Gate-Drain Charge  | $Q_{gd}$      |   | --    | 9    | --        |            |
| Turn-on Delay Time   | $t_{d(on)}$   | $V_{DD} = -30V,$<br>$I_D = -12A,$<br>$R_G = 3\Omega$      | --    | 10   | --        | ns         |
| Turn-on Rise Time  | $t_r$         |   | --    | 6    | --        |            |
| Turn-off Delay Time  | $t_{d(off)}$  |   | --    | 44   | --        |            |
| Turn-off Fall Time   | $t_f$         |   | --    | 12   | --        |            |
| <b>Drain-Source Body Diode Characteristics</b>                   |               |   |       |      |           |            |
| Continuous Body Diode Current                                    | $I_S$         | $T_C = 25^\circ\text{C}$                                  | --    | --   | -6        | A          |
| Body Diode Voltage   | $V_{SD}$      | $T_J = 25^\circ\text{C}, I_{SD} = -12A, V_{GS} = 0V$      | --    | --   | -1.2      | V          |
| Reverse Recovery Charge  | $Q_{rr}$      | $I_F = -12A, V_{GS} = 0V$<br>$di/dt = -100A/\mu s$        | --    | 47   | --        | nC         |
| Reverse Recovery Time  | $T_{rr}$      |   | --    | 34   | --        | ns         |

### Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. EAS condition :  $T_J = 25^\circ\text{C}, V_{DD} = -50V, V_{GS} = -10V, L = 0.5\text{mH}, R_G = 25\Omega$
3. Identical low side and high side switch with identical  $R_G$

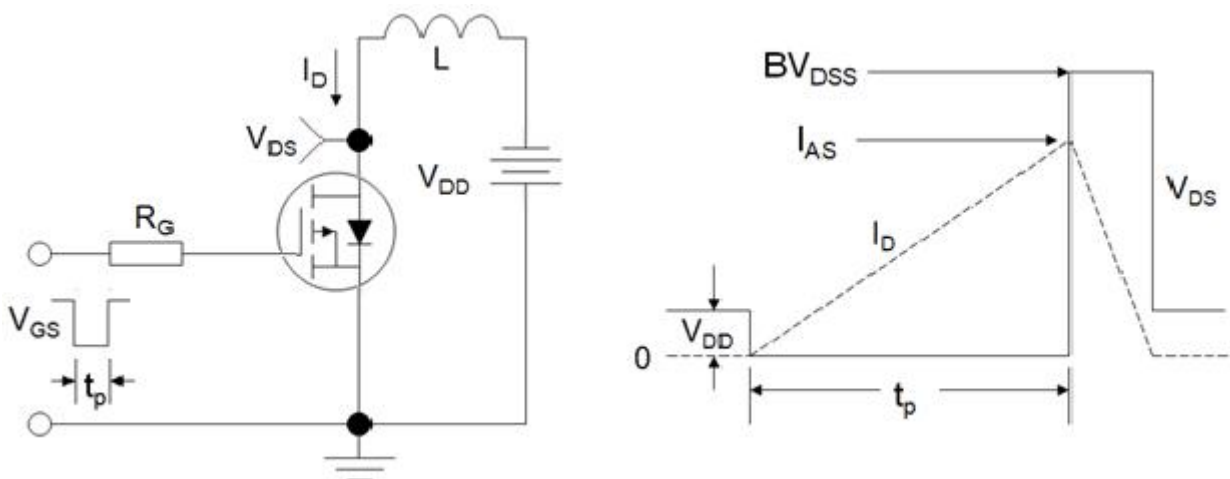
### Gate Charge Test Circuit



### Switch Time Test Circuit

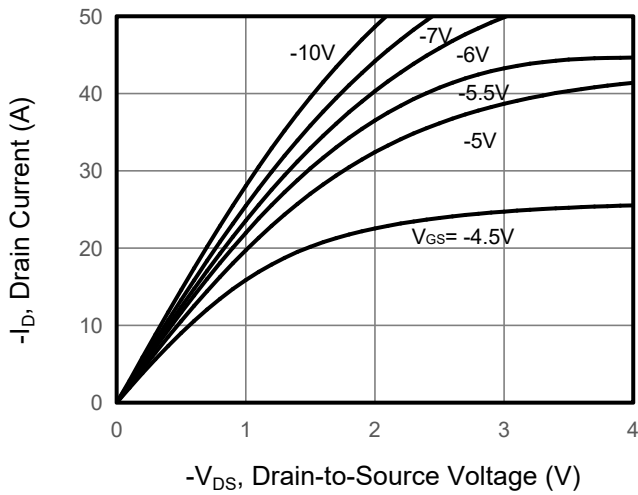


### EAS Test Circuit

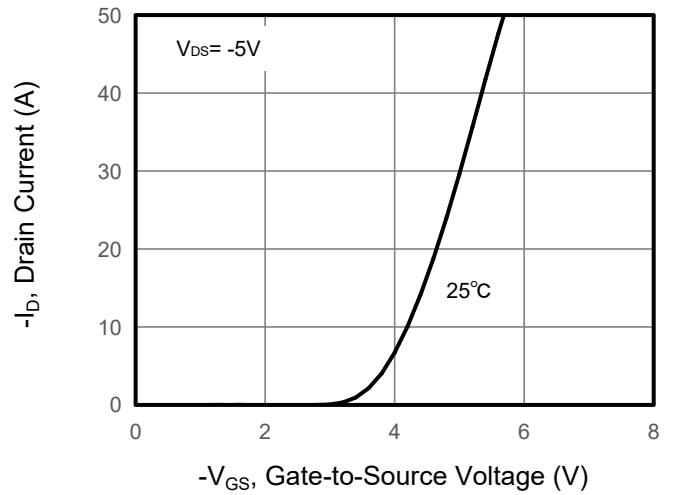


Typical Characteristics  $T_J = 25^\circ\text{C}$ , unless otherwise noted

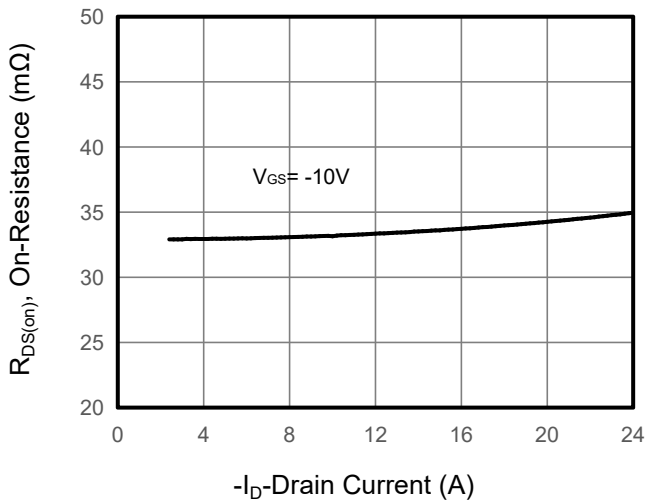
**Figure 1. Output Characteristics**



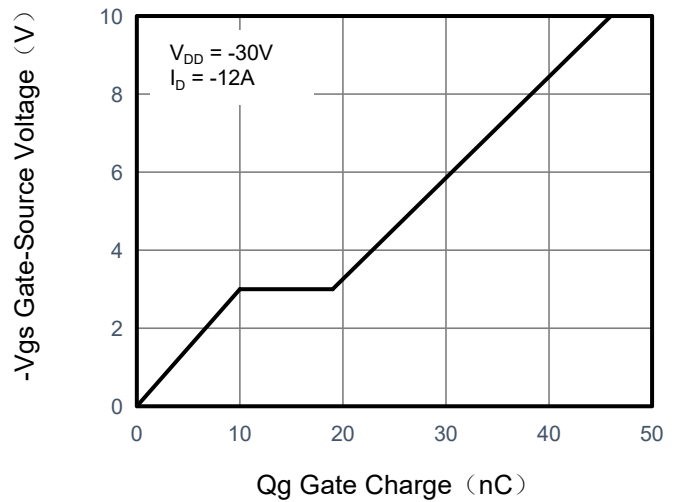
**Figure 2. Transfer Characteristics**



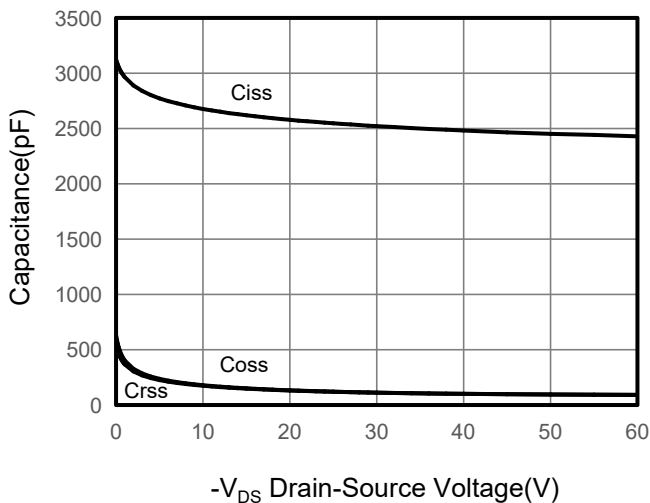
**Figure 3. Drain Source On Resistance**



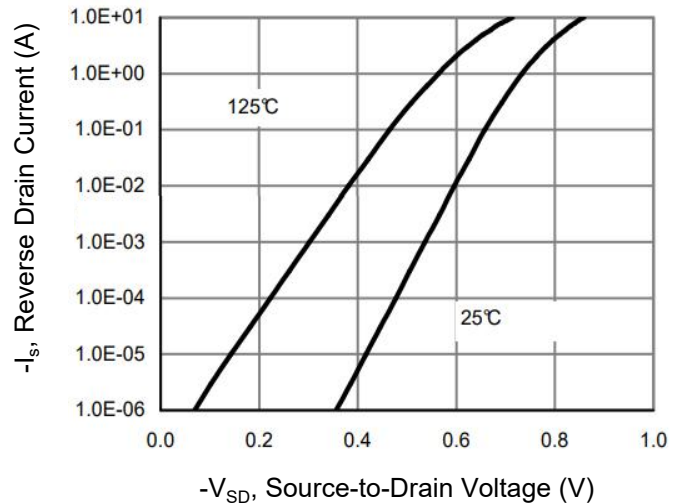
**Figure 4. Gate Charge**



**Figure 5. Capacitance**



**Figure 6. Source-Drain Diode Forward**



## Typical Characteristics $T_J = 25^\circ\text{C}$ , unless otherwise noted

Figure 7. Drain-Source On-Resistance

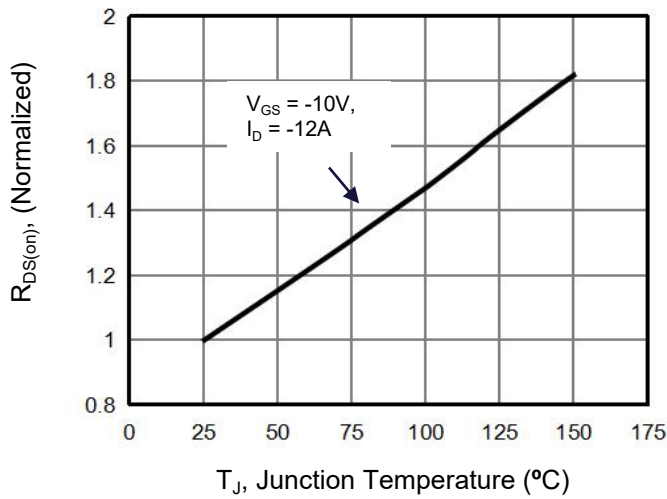


Figure 10. Safe Operation Area

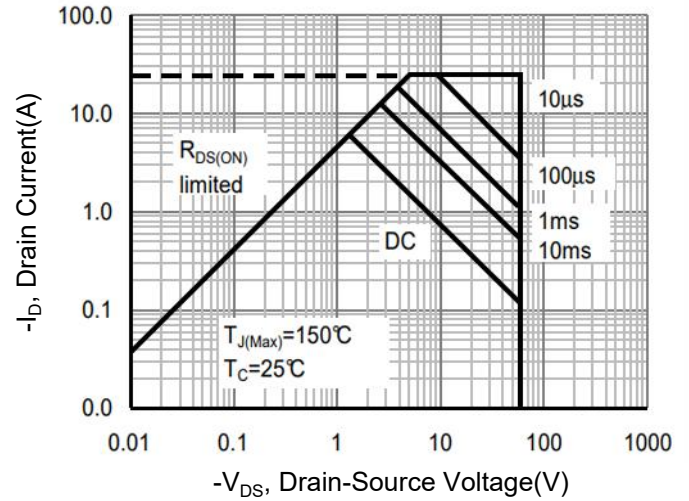
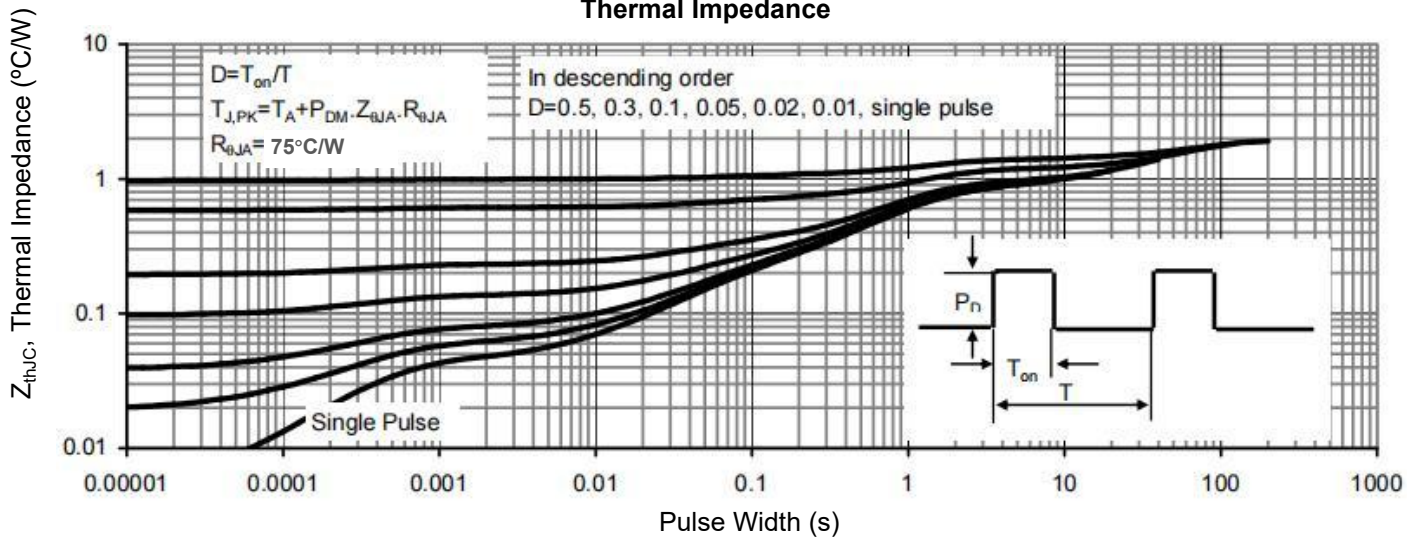
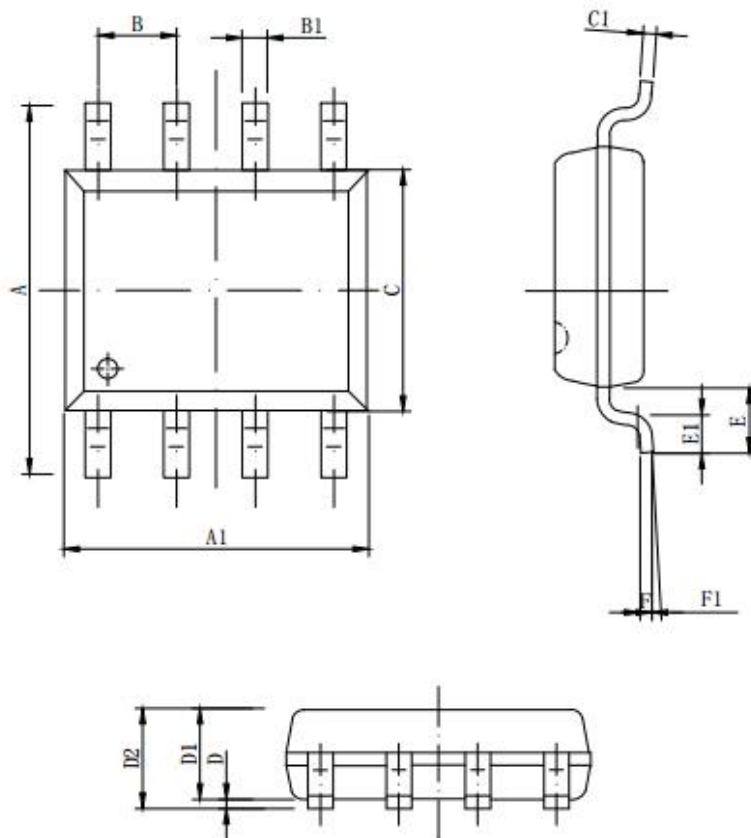


Figure 9. Normalized Maximum Transient Thermal Impedance



## SOP-8 Package Information



| Symbol | Dimensions in Millimeters |                    |                    |
|--------|---------------------------|--------------------|--------------------|
|        | MIN.                      | NOM.               | MAX.               |
| A      | 5.800                     | 6.000              | 6.200              |
| A1     | 4.800                     | 4.900              | 5.000              |
| B      | 1.270BSC                  |                    |                    |
| B1     | 0.35 <sup>8x</sup>        | 0.40 <sup>8x</sup> | 0.45 <sup>8x</sup> |
| C      | 3.780                     | 3.880              | 3.980              |
| C1     | --                        | 0.203              | 0.253              |
| D      | 0.050                     | 0.150              | 0.250              |
| D1     | 1.350                     | 1.450              | 1.550              |
| D2     | 1.500                     | 1.600              | 1.700              |
| D2     | 1.500                     | 1.600              | 1.700              |
| E      | 1.060REF                  |                    |                    |
| E1     | 0.400                     | 0.700              | 0.100              |
| F      | 0.250BSC                  |                    |                    |
| F1     | 2°                        | 4°                 | 6°                 |